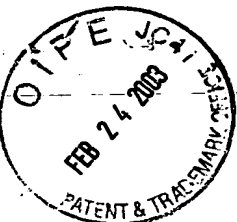


1725



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#7

In re the Application of

Ikuya MIYAZAWA

Application No.: 10/090,142

Filed: March 5, 2002

For: SOLDERING METHOD, SOLDERING DEVICE, AND METHOD AND DEVICE OF  
FABRICATING ELECTRONIC CIRCUIT MODULE

RECEIVED

FEB 27 2003

GROUP 1700

Group Art Unit: 1725

Docket No.: 112155

INFORMATION DISCLOSURE STATEMENT


Director of the U.S. Patent and Trademark Office  
Washington, D.C. 20231

Sir:

Pursuant to 37 CFR §1.56, the attention of the Patent and Trademark Office is hereby directed to the references listed on the attached PTO-1449. Unless otherwise indicated herein, one copy of each reference is attached. It is respectfully requested that the information be expressly considered during the prosecution of this application, and that the references be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

- ☒ 1. This Information Disclosure Statement is being filed (a) within three months of the U.S. filing date of this non-CPA application, OR (b) before the mailing date of a first Office Action on the merits in the present application. No certification or fee is required.
- ☒ 2. English-language Translations of the non-English language references are attached hereto.

Respectfully submitted,

  
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Date: February 25, 2003

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